

CBR06C608B5GACAUTO

CBR-SMD RF Auto COG, Ceramic, 0.6 pF, +/-0.1 pF, 50 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0603



Click here for the 3D model.

Dimensions	
Chip Size	0603
L	1.6mm +/-0.1mm
W	0.8mm +/-0.1mm
Т	0.8mm +/-0.1mm
В	0.4mm +/-0.2mm

Packaging Specifications	
Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	4000

General Information		
Series	CBR-SMD RF Auto COG	
Style	SMD Chip	
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I	
Features	Ultra High Q, Low ESR, Class I	
RoHS	Yes	
Termination	Tin	
Marking	No	
Qualifications	AEC-Q200	
AEC-Q200	Yes	
Halogen Free	Yes	
Notes	Solder Wave or Solder Reflow.	
Shelf Life	78 Weeks	
MSL	1	

Specifications				
Capacitance	0.6 pF			
Capacitance Tolerance	+/-0.1 pF			
Voltage DC	50 VDC			
Dielectric Withstanding Voltage	125 VDC			
Temperature Range	-55/+125°C			
Temperature Coefficient	COG			
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MHz 1.0Vrms			
Dissipation Factor	0.24% 1 MHz 1.0Vrms			
Aging Rate	0% Loss/Decade Hour			
Insulation Resistance	10 GOhms			
Quality Factor	412			

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